

Amendments to the Claims

This listing of claims will replace all prior versions, and listing, of claims in the application:

Listing of Claims:

1. (original) A smart card web comprising a carrier web which comprises circuitry patterns, each having an integrated circuit, at suitable spaces one after another or next to each other and at least one cover web attached to the carrier web wherein the carrier web and the cover web are attached by a thermoplastic adhesive bonding film web.
2. (original) The smart card web according to claim 1, wherein the smart card web comprises several cover web layers which are attached to each other by thermoplastic adhesive bonding film webs.
3. (original) The smart card web according to claim 2, wherein the material of the thermoplastic adhesive bonding film is based on modified polyolefin or modified polyurethane.
4. (original) The smart card web according to claim 1, wherein the carrier web is made of polyester.
5. (original) The smart card web according to claim 1, wherein the cover web is made of polyvinyl chloride or polyester.
6. (original) The smart card web according to claim 1, wherein at the location of the chip there is a cavity in the cover web.
7. (original) The smart card web according to claim 1, wherein the thermoplastic adhesive bonding film web is arranged to cover the chip.
8. (original) An intermediate product for producing a smart card comprising a carrier

sheet which comprises at least one circuitry pattern having an integrated circuit and at least one cover sheet attached to the carrier sheet, wherein the carrier sheet and the cover sheet are attached by a thermoplastic adhesive bonding film.

9. (new) A smart card web comprising a carrier web with a plurality of cavities adjacent each other along the carrier web;

circuitry patterns in at least one cavity, each pattern having an integrated circuit, each pattern adjacent the other along the carrier web;

at least one cover web overlying the carrier web and the at least one cavity; and

a thermoplastic adhesive bonding film between the carrier web and the cover web, the thermoplastic film adhesively affixing the overlying cover web to the carrier web.

10. (new) The smart card web according to claim 9, wherein the smart card web comprises several cover web layers which are attached to each other by thermoplastic adhesive bonding film webs.

11. (new) The smart card web according to claim 10, wherein the thermoplastic adhesive bonding film is selected from the group consisting of polyolefin and polyurethane.

12. (new) The smart card web according to claim 9, wherein the carrier web comprises polyester.

13. (new) The smart card web according to claim 9, wherein the cover web is selected from the group consisting of polyvinyl chloride and polyester.

14. (new) The smart card web according to claim 1, wherein the thermoplastic adhesive bonding film web is arranged to cover the chip.